

Mark Dominic Yamarone

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Skills

Applications: SOLIDWORKS, MatLab, Microsoft Office, Creo Parametric, NX, ANSYS, Confluence, Visio

Programming: Python, C++, Java, HTML, Amazon Web Services

Manufacturing: Sheet Metal Design, Milling, Composite Materials, DFM, Soldering, PCB Design, Rapid Prototyping

Professional Experience

- Elementary Robotics – Mechanical Engineer**, Pasadena, CA January 2020 – August 2022
- Developing hardware for the next generation of factory automation and product inspection.
 - Deploying and integrating inspection hardware to consumer product, industrial, and food safe manufacturing environments.
- MORSE Corp – Engineering Co-Op**, Cambridge, MA January 2019 – August 2019
- Designed structural components for unmanned aerial vehicles and their support systems in Solidworks.
 - Made hardware testing methods more reliable and consistent with automated tests and redundant safety systems.
- Endeavor Robotics – Systems Engineering Co-Op**, Chelmsford, MA January 2018 – June 2018
- Performed verification of robot performance in mobility, endurance, communications, and accessory interoperability.
 - Collaborated with team on planning and proposal for a major development contract with the US Army.
 - Designed a “Hardware-in-the-Loop” breakout system of chassis electronics for delivery to government customer.
 - Developed a custom test instrument to measure and record robot speed using Creo and Python tools such as Flask and Tkinter.
- Hasbro Inc. – Engineering Co-Op, Integrated Play**, Pawtucket, RI January 2017 – June 2017
- Engineered new play experiences for next-gen, connected toys using advanced technologies such as computer vision, virtual reality, and voice recognition; including speech based games for Amazon Alexa.
 - Created mock ups of mechanisms for future animatronic toys using both machined and 3D printed parts.
- NASA JPL – Eng. Undergrad Intern – ECOSTRESS**, La Cañada, CA May 2016 – August 2016
- Designed 10 data and power cables internal to the instrument as part of the project cabling team.
 - Supervised manufacturing of 30 cables and routed cables on the computer model of the instrument in Siemens NX.
 - Worked in a clean room environment with flight hardware including cables and satellite structures.
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Education

- Stanford University** 2022 – 2024
- M.S. Aeronautical/Astronautical Engineering
- Northeastern University**, G.P.A: 3.87 December 2019
- B.S. Mechanical Engineering, Minor in Electrical Engineering, *Summa Cum Laude*
- Relevant Courses:** Intro to Flight, Mechatronics, Fluid Mechanics, Systems and Controls
- Activities:** Wireless Club, Aero NU, NU Mars Rover Team, Pi Tau Sigma Honor Society, WRBB 104.9 FM
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Engineering Activities

- Avatar XPRIZE Arm Capstone Project** 2019
- With a team of 5, designed and prototyped an anthropomorphic robotic arm and haptic exoskeleton controller.
 - Developed a compact brushless motor driver for quasi-direct drive applications with precise torque control.
 - Developed FreeRTOS based firmware for control and low latency communications in C++.
- Northeastern University Mars Rover Team – Systems Engineering Lead** 2018 – 2019
- Designing a remotely operated planetary rover for a simulated Mars environment to compete in the University Rover Challenge.
 - Defining system requirements and engineering a solution best suited to complete competition tasks including autonomous navigation, sample collection, and tool grasping.
 - Managing the mechanical, electrical, and software design and integration of 4 subsystems.
- Aerospace NU – Fixed Wing Project Lead** 2015 – 2019
- Led the Fixed Wing team in creating a plane to compete in SAE Aero Design East 2019.
 - Created CAD, defined system architecture, and led propulsion and controls teams to meet competition requirements.
 - Manufactured airframe using laser-cut pieces, COTS model airplane components and 3D printed hardware.
- Northeastern Wireless Club – Facilities Manager, Secretary** 2015 – 2019
- Organized and led projects that provided students hand on experience with circuits, software, and mechanical design.